

LCD MODULE SPECIFICATION

Model: CG240160C - _ _ - _ - _ - _

Revision	00
Engineering	Jackson Fung
Date	26 June 2015
Our Reference	X9057

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MODE OF DISPLAY

Display mode **Display condition** Viewing direction STN: Yellow green Reflective type 6 O' clock Grey Transflective type 12 O' clock ☐ Blue (negative) Transmissive type 3 O' clock Others FSTN positive 9 O' clock FSTN negative LCD MODULE NUMBER NOTATION: <u>CG240160C- N N - S R - N 6 - T</u> *(1)---Model number of standard LCD Modules *(2)---Backlight type (1) N – No backlight (2) (3) (4) (5) (6) (7) (8) E – EL backlight L – Side-lited LED backlight M- Array LED backlight C-CCFL *(3)---Backlight color N – No backlight A – Amber B - BlueO- Orange W-White Y – Yellow green G-GreenR - Red*(4)---Display mode T - TNV – TN (Negative)

S – STN Yellow green

G – STN Grey

D CTN Dlug

B – STN Blue (Negative)

F-FSTN

N – FSTN (Negative)

*(5)---Rear polarizer type

R – Reflective

F-Transflective

T-Transmissive

*(6)---Temperature range

N-Normal

W- Extended

*(7)---Viewing direction

6 - 6 O'clock

2 – 12 O'clock

3 – 3 O'clock

9 – 9 O'clock

*(8)---Special code for other requirements (Can be omitted if not used)

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CG240160C

GENERAL DESCRIPTION

Display mode : 240 x 160 dots, Graphic COG LCD module

Interface : 8-bit parallel or 4-line serial

Driving method : 1/160 duty, 1/14 bias

Controller IC : Sitronix ST75256 or equivalent

For the detailed information, please refer to the IC specifications

MECHANICAL DIMENSIONS

Item	Dimension	Unit	Item	Dimension	Unit
Outline Dimensi	ion		Dot Size	0.295(L)x0.335(W)	mm
	94.0(L)x75.8(W)x2.9max(H)		Dot Pitch	0.32(L)x0.36 (W)	mm
No backlight	94.0(L)x75.8(W)x4.7max(H)(with touch panel)	mm		86.0(L)x62.8(W)	
	96.4(L)x78.2(W)x6.2max(H)		Viewing Area	80.9(L)x60.98(W)	mm
LED backlight	96.4(L)x78.2(W)x8.0max(H) (with touch panel)			(with touch panel)	

CONNECTOR PIN ASSIGNMENT

CN1:

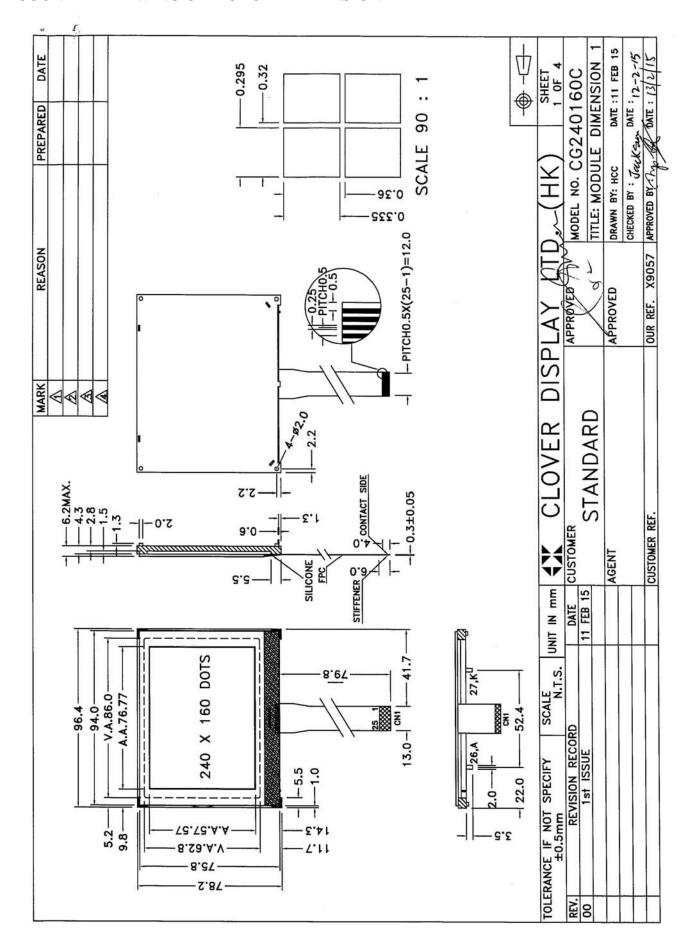
Pin No.	Symbol	Function
1	GND	Connect to GND
2~9	D7~D0	Data bus
10	RSTB	Reset
11	RWR	Read/Write execution control
12	ERD	Read/ write execution control
13	A0	Data/command display control
14	CSB	Chip select
15	IF0	Interface operation mode select
16	IF1	interface operation mode select
17	VD1S	Digital power source select
18	VSS	Ground
19	VDD	Supply voltage for logic
20	CA1N	DC/DC voltage converter
21	CA1P	DC/DC voltage converter
22	XV0	Negative operating voltage of COM-drivers
23	V0	Positive operating voltage of COM-drivers
24	VG	Power of SEG-drivers
25	GND	Connect to GND
26	A	Supply voltage for backlight(+)
27	K	Supply voltage for backlight(-)

CN2:

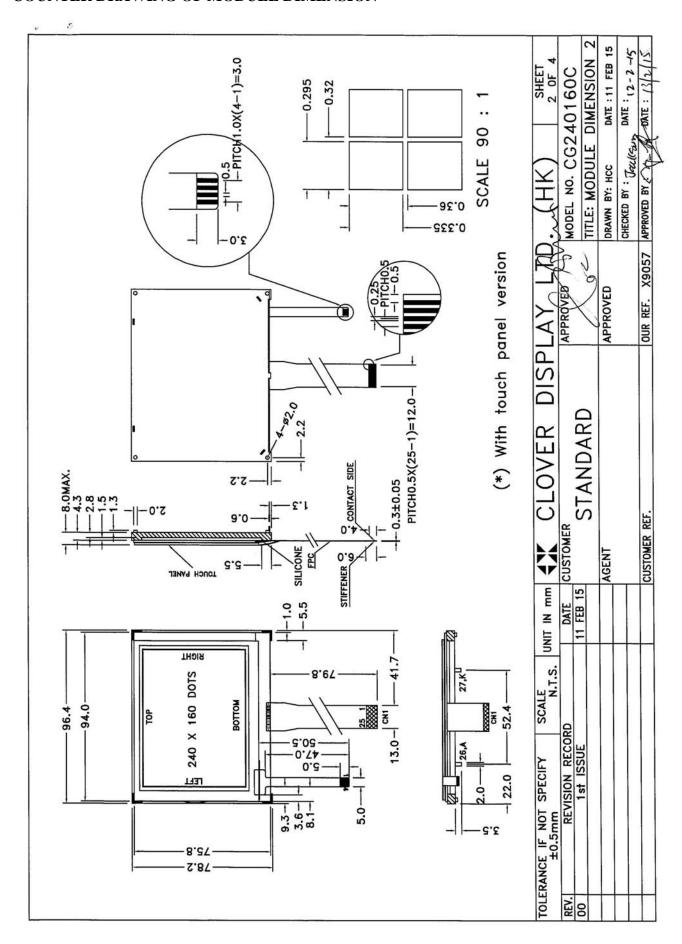
Pin No.	Symbol	Function					
1	TOP						
2	LEFT						
3	BOTTOM	Touch panel signal					
4	RIGHT						

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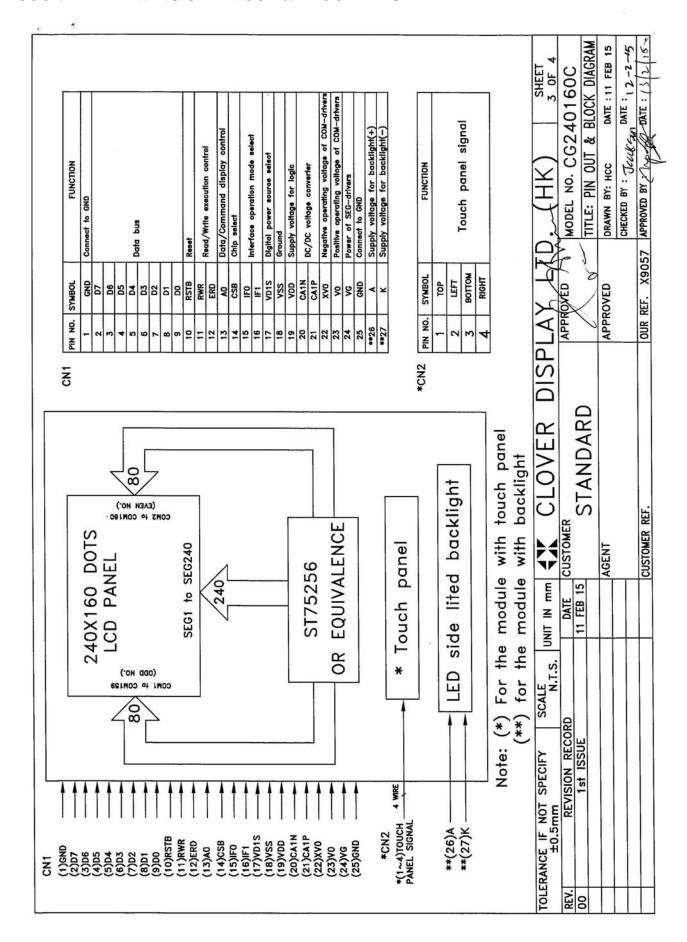
COUNTER DRAWING OF MODULE DIMENSION



COUNTER DRAWING OF MODULE DIMENSION



COUNTER DRAWING OF PIN OUT & BLOCK DIAGRAM



Conditions: VSS=0V, @Ta=25°C

ELECTRICAL CHARACTERISTICS

Item	Symbol	MIN.	TYP.	MAX.	Unit
Supply Voltage for Logic	VDD	3.05	3.3	3.55	V
Supply Current for Logic	IDD	_	2.5	_	mA
Operating Voltage for LCD (*)	V0	15.67	16.5	17.33	V
'High' Level Input Voltage	VIH	0.7VDD	_	VDD	V
'Low' Level Input Voltage	VIL	VSS	_	0.3VDD	V

Note (*): There is tolerance in optimum LCD driving voltage during production and it will be within the specified range.

Side BL:

Constant voltage driving:

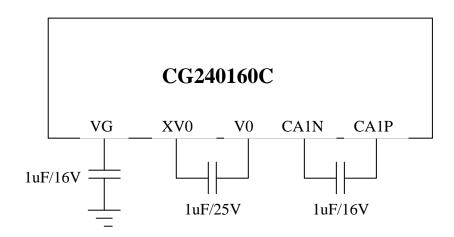
Item	Symbol	MIN.	TYP.	MAX.	Unit	Condition
White	I_{BL}	_	60	90	mA	$V_{BL} = 3.3V$
Blue	I_{BL}	_	90	120	mA	$V_{BL} = 3.3V$

ABSOLUTE MAXIMUM RATINGS

Please make sure not to exceed the following maximum rating values under the worst application conditions

Item	Symbol	Rating (for normal temperature)	Rating (for wide temperature)	Unit
Supply Voltage	Vdd	-0.3 to 4.0	-0.3 to 4.0	V
Input Voltage	Vi	-0.3 to VDD+0.3	-0.3 to VDD+0.3	V
Operating Temperature	Topr	0 to 50	-20 to 70	$^{\circ}\mathbb{C}$
Storage Temperature	Tstg	-10 to 60	-30 to 80	$^{\circ}\!\mathbb{C}$

REFERENCE CIRCUIT EXAMPLE



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INSTRUCTION TABLE

INSTRUCTION	Α0	R/W			C	AMMC	ND BY	TE			DESCRIPTION	
INSTRUCTION	AU	IK/VV	D7	D6	D5	D4	D3	D2	D1	D0	DESCRIPTION	
1.Extension Command	0	0	0	0	1	1	EXT1	0	0	EXT0	Set extension instruction	
Ext[1:0]=0,0 (Extensio	d 1)			1			l	l	l			
2.Display ON/OFF	0	0	1	0	1	0	1	1	1	DSP	Set LCD display DSP=0: Display off DSP=1: Display on	
3.Inverse Display	0	0	1	0	1	0	0	1	1	INV	Set inverse display INV=0: Normal display INV=1: Inverse display	
4.All Pixel ON/OFF	0	0	0	0	1	0	0	0	1	AP	Set all pixel on mode AP=0: All pixel off mode AP=1: All pixel on mode	
	0	0	1	1	0	0	1	0	1	0	Set display control CLD :Set CL dividing ratio	
5.Display Control	1	0	0	0	0	0	0	CLD	0	0	LF[4:0] : Set N-line inversion counter	
	1	0	DT7	DT6	DT5	DT4	DT3	DT2	DT1	DT0	DT[7:0] : Set the number of duty FI : Set the inversion type of	
	1	0	0	0	LF4	FI	LF3	LF2	LF1	LF0	frame at the end of common scan cycle	
6.Power Save	0	0	1	0	0	1	0	1	0	SLP	Set power save mode SLP=0: Sleep out mode SLP=1: Sleep in mode	
	0	0	0	1	1	1	0	1	0	1	Set Page Address Starting Page address:	
7.Set Page Address	1	0	YS7	YS6	YS5	YS4	YS3	YS2	YS1	YS0	00h≦YS≦28h Ending Page address:	
	1	0	YE7	YE6	YE5	YE4	YE3	YE2	YE1	YE0	YS≦YE≦28h	
	0	0	0	0	0	1	0	1	0	1	Set Column Address Starting Column address:	
8.Set Column Address	1	0	XS7	XS6	XS5	XS4	XS3	XS2	XS1	XS0	00h≦XS≦FFh Ending Column address:	
	1	0	XE7	XE6	XE5	XE4	XE3	XE2	XE1	XE0	XS≦XE≦FFh	
9.Data Scan Direction	0	0	1	0	1	1	1	1	0	0	Set normal/ inverse display of address and address scan	
	1	0	0	0	0	0	0	C/L	MX	MY	direction	
10.Write Data	0	0	0	1	0	1	1	1	0	0	Write data to DDRAM	
	1	0	D7	D6	D5	D4	D3	D2	D1	D0		
11.Read Data	0	0	0	1	0	1	1	1	0	1	Read data from DDRAM	
Tilloud Buld	1	1	D7	D6	D5	D4	D3	D2	D1	D0	TOUG GGIG HOTE DELVIN	
	0	0	1	0	1	0	1	0	0	0	Set partial area Starting partial display address:	
12.Partial In	1	0	PTS7	PTS6	PTS5	PTS4	PTS3	PTS2			00h≦PTS≦A1h Ending partial display address:	
	1	0	PTE7	PTE6	PTE5	PTE4	PTE3	PTE2	PTE1	PTE0	00h≦PTE≦A1h	

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INCTRUCTION		DAM	İ		C	OMMAI	ND BY	ΤE			DESCRIPTION	
INSTRUCTION	A0	R/W	D7	D6	D5	D4	D3	D2	D1	D0	DESCRIPTION	
13.Partial Out	0	0	1	0	1	0	1	0	0	1	Exit the partial mode	
14.Read/Modify/Write In	0	0	1	1	1	0	0	0	0	0	Enable read modify write	
15.Read/Modify/Write Out	0	0	1	1	1	0	1	1	1	0	Disable read modify write	
	0	0	1	0	1	0	1	0	1	0		
	1	0	TL7	TL6	TL5	TL4	TL3	TL2	TL1	TL0		
16.Scroll Area	1	0	BL7	BL6	BL5	BL4	BL3	BL2	BL1	BL0	Set scroll area	
	1	0	NSL7	NSL6	NSL5	NSL4	NSL3	NSL2	NSL1	NSL0		
	1	0	0	0	0	0	0	0	SCM1	SCM0		
47.0 (0) (1)	0	0	1	0	1	0	1	0	1	1	Set scroll start address	
17.Set Start Line	1	0	SL7	SL6	SL5	SL4	SL3	SL2	SL1	SL0	00h≦SL≦A1h	
18.OSC ON	0	0	1	1	0	1	0	0	0	1	Turn on the internal oscillator	
19.OSC OFF	0	0	1	1	0	1	0	0	1	0	Turn off the internal oscillator	
00.0	0	0	0	0	1	0	0	0	0	0	Power circuit operation VB=0: OFF, VB=1: ON	
20.Power Control	1	0	0	0	0	0	VB	0	VF	VR	VF=0: OFF, VF=1: ON VR=0: OFF, VR=1: ON	
	0	0	1	0	0	0	0	0	0	1		
21.Set Vop	1	0	0	0	Vop5	Vop4	Vop3	Vop2	Vop1	Vop0	Set Vop	
	1	0	0	0	0	0	0	Vop8	Vop7	Vop6		
22.Vop Control	0	0	1	1	0	1	0	1	1	VOL	Control Vop VOL=0: Vop increase one step VOL=1: Vop decrease one step	
23.Read Register Mode	0	0	0	1	1	1	1	1	0	REG	Set read register mode REG=0: read the register value of VPR[5:0] REG=1: read the register value of VPR[8:6]	
24.Nop	0	0	0	0	1	0	0	1	0	1	No operation	
25.Read Status	0	1	D7	D6	D5	D4	D3	D2	D1	D0	Read status byte	
26.Data Format Select	0	0	0	0	0	0	1	DO	0	0	DO=0; LSB on bottom (Default) DO=1; LSB on top	
O7 Diamles Mede	0	0	1	1	1	1	0	0	0	0	Set display mode	
27. Display Mode	1	0	0	0	0	1	0	0	0	DM	DM=0 :Mono(Default) DM=1 :4Gray Scale Mode	
28.ICON Control	0	0	0	1	1	1	0	1	1	ICON	Enable/Disable ICON ICON=1 ; Enable ICON=0 ; Disable	

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INSTRUCTION	Α0	R/W			C	ОММА	ND BY	TE			DESCRIPTION	
			D7	D6	D5	D4	D3	D2	D1	D0	DESCRIPTION	
Ext[1:0]=0,1 (Extensio	n Con		d 2)	ı	1		1		1			
	0	0	0	0	1	1	0	0	1	0		
29.Analog Circuit Set	1	0	0	0	0	0	0	0	0	0	Set analog set BE[1:0]: Booster efficiency set	
	1	0	0	0	0	0	0	0	BE1	BE0	BS[2:0]: Set bias ratio	
	1	0	0	0	0	0	0	BS2	BS1	BS0		
30.Booster Level	0	0	0	1	0	1	0	0	0	1	Set booster level	
OU.DOUSICI LEVEI	1	0	1	1	1	1	1	0	1	BST	Oct Booster level	
31. Driving Select	0	0	0	1	0	0	0	0	0	DS	Power type DS=0: Internal (Default) DS=1 :External	
32.High Power Mode	0	0	0	1	0	0	1	0	0	HPM	Set high power mode HPM=0 ; Normal Mode HPM =1 ; High Power Mode	
	0	0	1	1	0	1	0	1	1	1	Set auto-read instruction	
33.Auto Read Control	1	0	1	0	0	XARD	1	1	1	1	XARD=0: Enable auto read XARD=1: Disable auto read	
34.OTP WR/RD Control	0	0	1	1	1	0	0	0	0	0	OTP WR/RD control	
	1	0	0	0	WR/ RD	0	0	0	0	0	WR/RD=0: Enable OTP read WR/RD=1: Enable OTP write	
35.OTP Control Out	0	0	1	1	1	0	0	0	0	1	OTP control out	
36.OTP Write	0	0	1	1	1	0	0	0	1	0	OTP write	
37.OTP Read	0	0	1	1	1	0	0	0	1	1	OTP read	
38.OTP Selection	0	0	1	1	1	0	0	1	0	0	OTP selection control	
Control	1	0	1	Ctrl	0	1	1	0	0	1	Ctrl=1: Disable OTP Ctrl=0: Enable OTP	
39.OTP Programming	0	0	1	1	1	0	0	1	0	1		
Setting	1	0	0	0	0	0	1	1	1	1	OTP programming setting	
	0	0	1	1	1	1	0	0	0	0		
	1	0	0	0	0	FRA4	FRA3	FRA2	FRA1	FRA0		
40.Frame Rate	1	0	0	0	0	FRB4	FRB3	FRB2	FRB1	FRB0	Frame rate setting in different temperature range	
	1	0	0	0	0			FRC2			temperature range	
	1	0	0	0	0	FRD4	FRD3	FRD2	FRD1	FRD0		
	0	0	1	1	1	1	0	0	1	0		
41.Temperature	1	0	0	TA6	TA5	TA4	TA3	TA2	TA1	TA0		
Range	1	0	0	TB6	TB5	TB4	TB3	TB2	TB1	TB0	Temperature range setting	
	1	0	0	TC6	TC5	TC4	TC3	TC2	TC1	TC0		

RECOMMENDED INITIAL SETTINGS

Set Start Line: ABH,00H

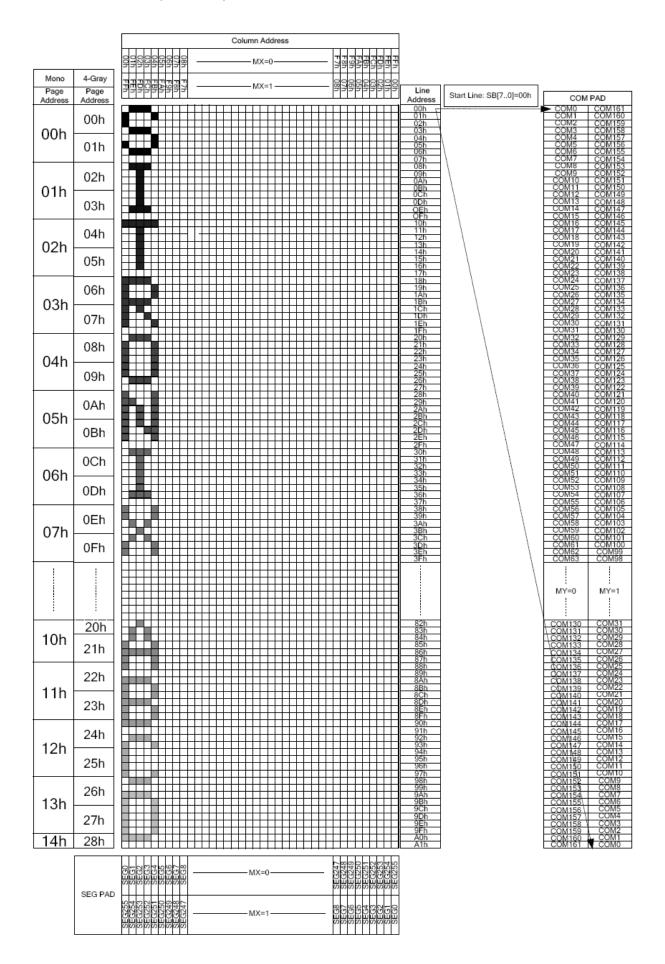
Set Page Address: 7AH,00H,28H Set Column Address: 1AH,00H,FFH Set data scan Direction: BCH,00H Set Power Control: 20H,0BH

Set Vop: 81H,3AH,05H Set Vop control: C6H Set Display On: AFH

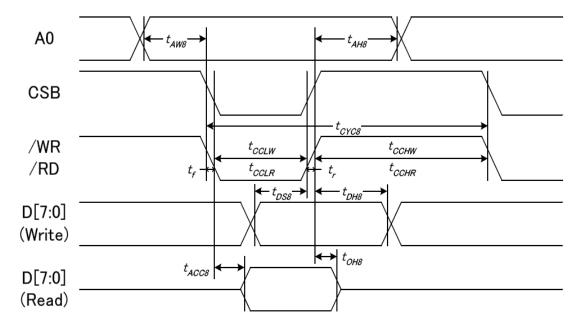
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DISPLAY DATA RAM (DDRAM)



8080 MCU INTERFACE TIMING



VDD1 = 1.8~3.3V, Ta = 25°C

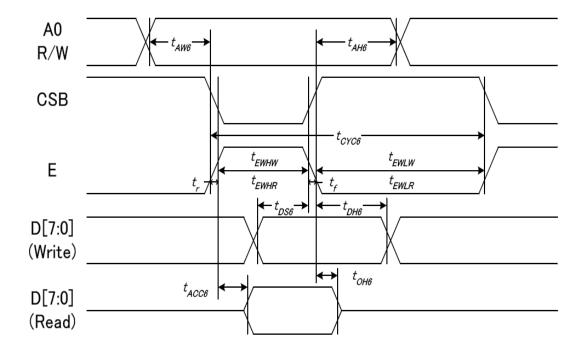
ltem	Signal	Symbol	Condition	Min.	Max.	Unit
Address setup time	- A0	tAW8		20	_	
Address hold time	AU	tAH8		0	_	
System cycle time (WRITE)		tCYC8		160	_	
/WR L pulse width (WRITE)	WR	tCCLW		70	_	
/WR H pulse width (WRITE)		tCCHW		70	_	
System cycle time (READ)		tCYC8		400	_	
/RD L pulse width (READ)	RD	tCCLR		180		ns
/RD H pulse width (READ)]	tCCHR		180		
WRITE Data setup time		tDS8		15	_	
WRITE Data hold time	D(7:01	tDH8		15	_	
READ access time	D[7:0]	tACC8	CL = 30 pF	_	100	
READ Output disable time		tOH8	CL = 30 pF	10	110	

Note:

- 1. The input signal rise time and fall time (tr, tf) is specified at 15 ns or less. When the system cycle time is extremely fast, $(tr + tf) \le (tCYC8 tCCLW tCCHW)$ for $(tr + tf) \le (tCYC8 tCCLR tCCHR)$ are specified.
- 2. All timing is specified using 20% and 80% of VDD1 as the reference.
- 3. tCCLW and tCCLR are specified as the overlap between CSB being "L" and WR and RD being at the "L" level.

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6800 MCU INTERFACE TIMING



VDD1 = 1.8~3.3V, Ta = 25°C

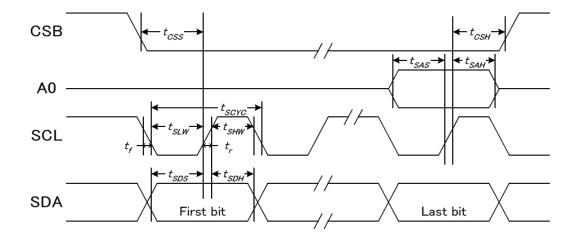
ltem	Signal	Symbol	Condition	Min.	Max.	Unit
Address setup time	۸٥	tAW6		20	_	
Address hold time	- A0	tAH6		0	_	
System cycle time (WRITE)		tCYC6		160	_	
Enable L pulse width (WRITE)		tEWLW		70	_	
Enable H pulse width (WRITE)	E	tEWHW		70	_	
System cycle time (READ)		tCYC6		400		no
Enable L pulse width (READ)		tEWLR		180	_	ns
Enable H pulse width (READ)		tEWHR		180		
Write data setup time		tDS6		15	_	
Write data hold time	D(7:01	tDH6		15	_	
Read data access time	D[7:0]	tACC6	CL = 30 pF	_	100	
Read data output disable time		tOH6	CL = 30 pF	10	110	

Note:

- 1. The input signal rise time and fall time (tr, tf) is specified at 15 ns or less. When the system cycle time is extremely fast, $(tr + tf) \le (tCYC6 tEWLW tEWHW)$ for $(tr + tf) \le (tCYC6 tEWLR tEWHR)$ are specified.
- 2. All timing is specified using 20% and 80% of VDD1 as the reference.
- 3. tEWLW and tEWLR are specified as the overlap between CSB being "L" and E.

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4-LINE SPI MCU INTERFACE TIMING



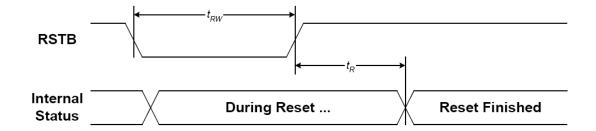
VDD1 = 1.8~3.3V, Ta = 25°C

Item	Signal	Symbol	Condition	Min.	Max.	Unit
Serial clock period	SCLK	tSCYC		60	_	
SCLK "H" pulse width		tSHW		30	_	
SCLK "L" pulse width		tSLW		30	_	
Address setup time	A0	tSAS		20	_	
Address hold time		tSAH		20	_	
Data setup time	SD4	tSDS		20	_	ns
Data hold time	SDA	tSDH		20	_	
CSB-SCLK time	CSB	tCSS		20	_	
CSB-SCLK time		tCSH		20	_	
CS "H" pulse width		tCHW		0	-	1

Note:

- 1. The input signal rise and fall time (tr, tf) are specified at 15 ns or less.
- 2. All timing is specified using 20% and 80% of VDD1 as the standard.

RESET TIMING



VDD1 = 1.8~3.3V, Ta = 25°C

ltem	Symbol	Condition	Min.	Max.	Unit
Reset time	tR		_	1	ms
Reset "L" pulse width	tRW		1	_	ms

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ELECTRO-OPTICAL CHARACTERISTICS

MEASURING CONDITION: POWER SUPPLY = V_{OP} / 64 Hz

TEMPERATURE = 23 ± 5 °C RELATIVE HUMIDITY = 60 ± 20 %

ITEM	SYMBOL	UNIT	TYP. STN
RESPONSE TIME	Ton	ms	320
	Toff	ms	430
CONTRAST RATIO	Cr	-	8
	V3:00	0	40
VIEWING ANGLE	V6:00	0	55
(6 O'clock)	V9:00	0	40
Cr ≥ 2	V12:00	0	35

THE ELECTRO-OPTICAL CHARACTERISTICS ARE MEASURED VALUE BUT NOT GUARANTEED ONES.

RELIABILITY OF LCD MODULE

		TEST CONDITION TEST CONDITION		
NO.	Item	FOR NORMAL TEMPERATURE	FOR WIDE TEMPERATURE	TIME
1	High temperature operating	50°C	70°C	240 hours
2	Low temperature operating	0°C	-20°C	240 hours
3	High temperature storage	60°C	80°C	240 hours
4	Low temperature storage	-10°C	-30°C	240 hours
5	Temperature-humidity storage	40°C 90% R.H.	60°C 90% R.H.	96 hours
6	Temperature cycling	-10°C to 60°C	-30°C to 80°C	5 cycle
		30 Min Dwell	30 Min Dwell	3 Cycle
7	Vibration Test at LCM Level	Freq 10-55 Hz	Freq 10-55 Hz	
		Sweep rate: 10-55-10 at 1 min	Sweep rate: 10-55-10 at 1 min	
		Sweep mode Linear	Sweep mode Linear	_
		Displacement: 2 mm p-p	Displacement: 2 mm p-p	
		1 Hour each for X, Y, Z	1 Hour each for X, Y, Z	

Inspection condition:

No. 1 ~ 6:

The samples should be placed in room temperature for 2 hours before inspection.

Acceptance criteria:

No non-conformance found in functional and cosmetic.

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SAMPLING METHOD

SAMPLING PLAN: MIL-STD 105E

CLASS OF AQL: LEVEL II/ SINGLE SAMPLING

MAJOR-0.65% MINOR – 1.5%

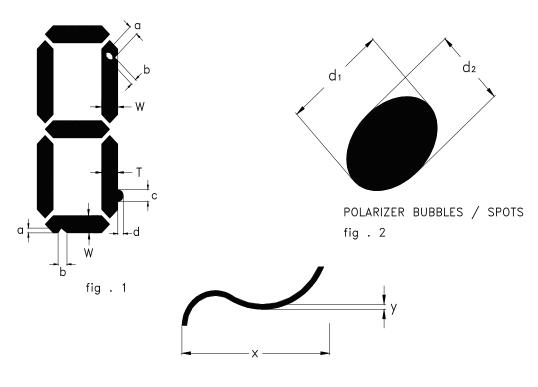
QUALITY STANDARD

DEFECT	CRITERIA		ТҮРЕ	FIGURE
SHORT CIRCUIT	-		MAJOR	-
MISSING SEGMENT	-		MAJOR	-
UNEVEN / POOR CONTRAST	-		MAJOR	-
CROSS TALK	-		MAJOR	-
PIN HOLE	$MAX(a,b) \leq$	1 / 4 W	MINOR	1
EXCESS SEGMENT	$MAX(c,d) \leq$	1 / 4 T	MINOR	1
BUBBLES	d* ≥ 0.2	QTY=0	MINOR	2
BLACKS SPOTS	d ≤ 0.3	N.A.**	MINOR	2
	0.3 <d≤0.4< td=""><td>QTY≤1</td><td></td><td></td></d≤0.4<>	QTY≤1		
	0.4 <d< td=""><td>QTY=0</td><td></td><td></td></d<>	QTY=0		
LINE SCRATCHES	x≥0.7 y≥0.05	QTY=0	MINOR	3
BLACK LINE	x≥0.7 y≥0.05	QTY=0	MINOR	3

 $*d = MAX(d_1,d_2)$

** N. A . = NOT APPLICABLE

DEFECT TABLE : B



LINE SCRATCHES / BLACK LINE fig . 3

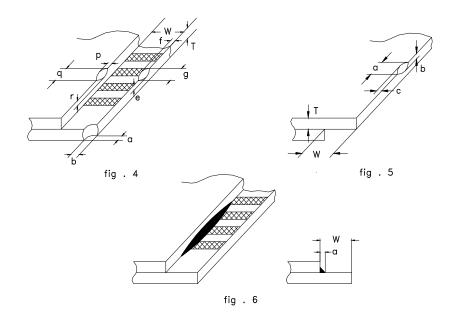
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QUALITY STANDARD (CONT.)

DEFECT		CRITERIA	ТҮРЕ	FIGURE
	CONTACT EDGE	e≤1/2T f≤1/3W g≤3.5		4
CHIPS	BOTTOM GLASS	p≤1.0 q≤3.5 r≤1/2T	MINOR	4
	CORNER	a≤1.5 b≤W		4
	TOP GLASS	a≤3.0 b≤1/3T c≤1/2W		5
GLASS PROTRUSION		a ≤ 1/4 W	MINOR	6
RAINBOW		-	MINOR	-

UNLESS STATE OTHERWISE , ALL UNIT ARE IN MILLIMETER .

DEFECT TABLE : B



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HANDLING PRECAUTIONS

(1) CAUTION OF LCD HANDLING & CLEANING

Use soft cloth with solvent (recommended below) to clean the display surface and wipe lightly.

- Isopropyl alcohol, ethyl alcohol, trichlorotriflorothane

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface. Do not use the following solvent;

-water, ketone, aromatics

(2) CAUTION AGAINST STATIC CHARGE

The LCD modules use CMOS LSI drivers, so customers are recommend that any unused input terminal would be connected to V_{DD} or V_{SS} , do not input any signals before power is turned on, and ground your body, work/assembly areas, assembly equipment to protect against static electricity.

Remove the protective film slowly and, if possible, under ESD control device like ion blower and humidity of working room should be kept over 50%RH to reduce risk of static charge.

(3) PACKAGING

Avoid intense shock and falls from a height and do not operate or store them exposed direct to sunshine or high temperature/humidity.

(4) CAUTION FOR OPERATION

It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage than the limit causes the shorter LCD life. The use of direct current drive should be avoided because an electrochemical reaction due to direct current causes LCD's undesirable deterioration.

Response time will be extremely delayed at low temperature, and LCD's show dark color at high temperature. However those phenomena do not mean malfunction or out of order with LCD's.

Some font will be abnormally displayed when the display area is pushed hard during operation. But it resumes normal condition after turning off once.

(5) SOLDERING (for Pin type)

It is recommended to complete dip soldering at $270\,^{\circ}\text{C}$ or hand soldering at $280\,^{\circ}\text{C}$ within 3 seconds. The soldering position is at least 3mm apart from the pin head. Wave or reflow soldering are not recommended. Metal pins should not be soldered for more than 3 times and each soldering should be done after cool down of metal pins

(6) SAFETY

For crash damaged or unnecessary LCD's, it is recommended to wash off liquid crystal by either of solvents such as acetone and ethanol and should be burned up later.

When any liquid leaked out of a damaged glass cell comes in contact with your hands, wash it off with soap and water.

WARRANTY

CLOVER will replace or repair any of her LCD module in accordance with her LCD specification for a period of one year from date of shipment. The warranty liability of Clover is limited to repair and/or replacement. Clover will not be responsible for any subsequent or consequential event.

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